PROTECT2024

9th International Colloquium on Performance, Protection & Strengthening of Structures Under Extreme Loading & Events

This conference has been awarded 18 PDUs by Singapore PE Board.

The PROTECT 2024 Steering Committee cordially invites you to the Nineth International Colloquium on Performance, Protection and Strengthening of Structures under Extreme Loading and Events.

PROTECT 2024 will bring together academics, industry personnel and practitioners from around the world to deliberate on the most up-to-date international research findings in this rapidly advancing field.

The primary objective of PROTECT 2024 is to provide a platform for students, faculty, producers, designers, builders and consultants to acquaint themselves with cutting-edge research. The ultimate aim of PROTECT 2024 is to enable cross-fertilization of ideas such that our structures become safer under extreme loading and events.



Singapore

KEYNOTE SPEAKERS



Prof Hao Hong Guangzhou University, China <u>Curtin University</u>, Australia

Prof Piotr W. Sielicki

Poznan University of Technology,

Poland



Prof Li Guoqiang Tongji University, China



Prof Vasant Matsagar Indian Institute of Technology, India



Prof Wu Bo South China University of Technology, *China*

KEY DEADLINES

<u>Acceptance notification</u>	<u>Submission of final</u>	<u>Early Bird</u>	<u>Regular Rate</u>	PROTECT 2024
of full paper to authors	<u>manuscript</u>	<u>Registration</u>	<u>Registration</u>	Conference
30 April 2024	15 May 2024	Ends on 30 May 2024	From 31 May 2024	13 - 16 August 2024

PROGRAMME AT A GLANCE

<u>13 - 15 August 2024</u>

• Plenary Speeches

- Abstract Presentations
- Special Sessions

<u>16 August 2024</u>

• Lab tour in Nanyang Technological University

VIEW PROGRAMME

REGISTRATION & FEES (USD)

Registration will be available online through the conference website.

	General	Author	Student
Before May 30, 2024	\$750	\$650	\$300
After May 31, 2024	\$900	\$800	\$450

ABSTRACT SUBMSSION

- In the abstract submission, kindly denote the presenter using the symbol (#). It is assumed that each abstract corresponds to a single presentation.
- It is NOT mandatory to submit a full paper to attend the conference, but authors are encouraged to submit their original and high-quality papers to PROTECT 2024.
- Only papers No less than 6 pages as per the template provided will be considered for publication in an indexed proceeding. 6 pages is the minimum, but hopefully 8-10 pages, and additional pages are welcome.
- All accepted conference papers will be published by Springer and indexed in Scopus, El-Compendex and Web of Science. *Authors of selected papers will be invited to submit extended manuscripts to Engineering Structures.*
- Best paper awards await high quality papers.
- Best presentation awards will be only awarded to PhD students.

Organised by :





NTU CEE Alumni Association

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Why singapore?



Where flowers blossom everyday!



Nanyang Technological University (Ranked 26th in QS)





School of Civil and Environmental Engineering (Civil and Structural Engineering ranked 9th in QS)

